



Docket No.: ION-0218  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Hiroyuki Okuhira et al.

Application No.: 10/717,586

Confirmation No.: 9398

Filed: November 21, 2003

Art Unit: 1712

For: CURING COMPONENT AND CURABLE  
RESIN COMPOSITION CONTAINING THE  
CURING COMPONENT

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Examiner: David J. Buttner

**AMENDMENT FILED WITH REQUEST FOR CONTINUED EXAMINATION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated June 9, 2006, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.